

SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40℃ to +105℃

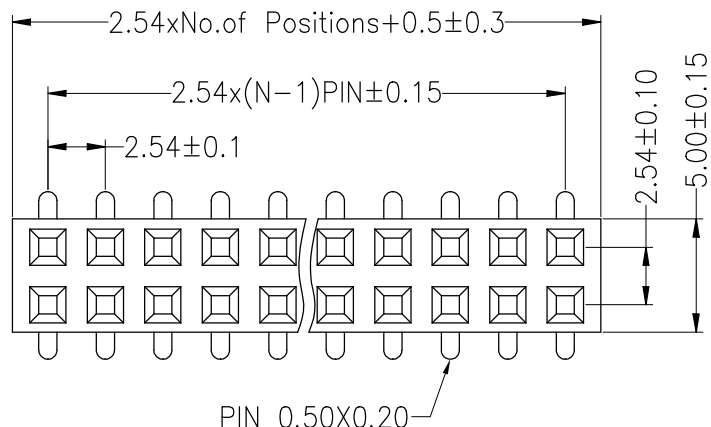
Contact Material:Brass

Contact Plating:Au or Sn Over Ni

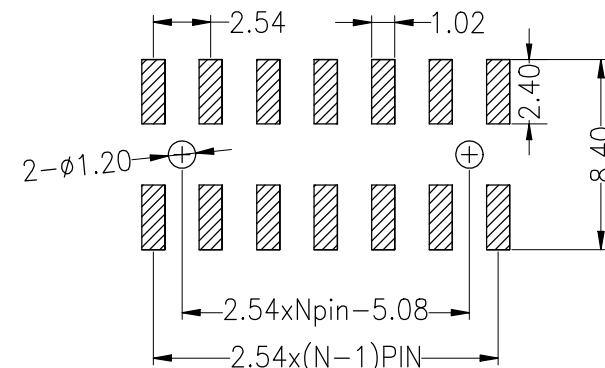
Insulator Material:Polyester(UL94V-0)

Resistance To Soldering Heat:

260℃±5℃, 10s(PA6T&PA9T&LCP insulator)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Ordering Information

2250 02 XX X W XX M U X 0X

No.of
Pins
Per Row
02~40P

Insulator Material
Option

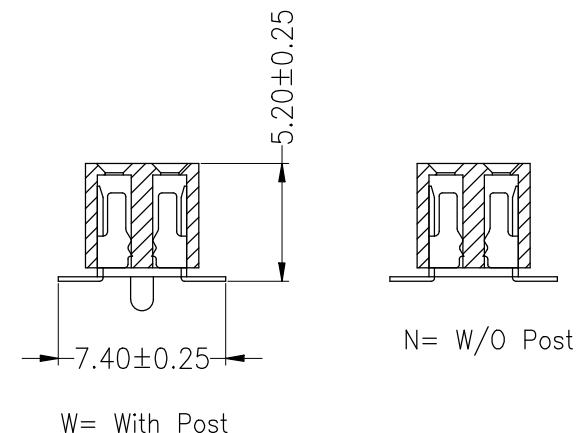
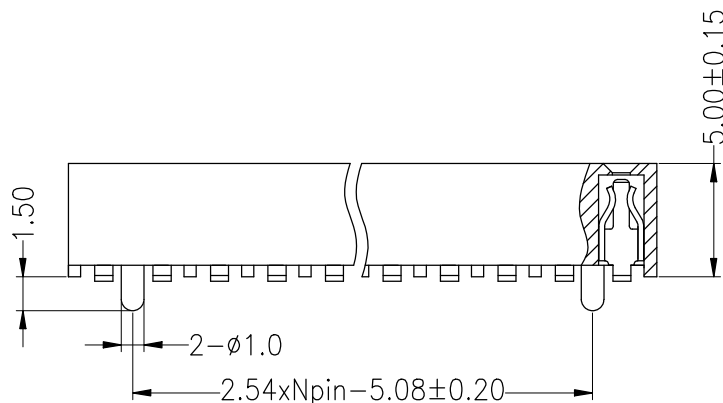
C=BK-PA6T
E=BK-PA9T
F=BK-LCP

Contact Plating

G1:Gold Flash
G2:1.5u" Gold
G3:2u" Gold
G4:3u" Gold
G5:5u" Gold
G6:10u" Gold
G7:15u" Gold
G8:30u" Gold
S0:Gold Flash/Tin
SN:Tin

Packing

T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar



				OPERATION		DRAW	YiYuSheng	15.01.23	SCALE	FIT	JILN® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				CHECK	UNIT		
				X.XX	±0.20	APPROVE	SIZE	A4				
A0	2015.01.23	NEW DRAWING		X.XXX	±0.10		SHEET	1/1				
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle	±3°				PROJ.		TITLE:	2.54PF H5.0mm 2xNpin SMT W7.40
				DIM	TOL							